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PATENT ASSIGNMENT

Electronic Version v08 Stylesheet Version v02

SUBMISSION TYPE:

NEW ASSIGNMENT

APPLICATION NUMBER

11/309225

NATURE OF CONVEYANCE:

ASSIGNMENT OF ASSIGNOR'S INTEREST

CONVEYING PARTY DATA

Name	Execution Date
CHENG-TIEN LAI	2006-06-02
ZHI-YONG ZHOU	2006-06-02
QIAO-LI DING	2006-06-02

RECEIVING PARTY DATA

Name	Street Address	Internal Address	City	State/Country	Postal Code
	3-2,CHUNG SHAN ROAD		Tu-Cheng,Taipei Hsien	TAIWAN	

CORRESPONDENCE DATA

FAX NUMBER: 7147384649

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the

official record on file at the USPTO.

CUSTOMER NUMBER: 054000

 NAME OF PERSON SIGNING:
 Jeffrey T. Knapp

 DATE SIGNED:
 2006-07-13

Total Attachments: 2 source=US9368assign1.tif source=US9368assign2.tif

PATENT REEL: 017930 FRAME: 0367

800026348

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

l,	Cheng-Tien Lai	_, residing at	Tu-Cheng, Taiwan
2,	Zhi-Yong Zhou	_, residing at	Shenzhen, China
3,	Qiao-Li Ding	_, residing at	Shenzhen, China
4,		_, residing at	
5.		_, residing at	
5.		_, residing at	
7.		_, residing at	
8.	_	_, residing at	

hereby sell(s), assign(s) and transfer(s) unto: <u>Foxconn Technology Co.,Ltd</u>, having a principal place of business at <u>3-2</u>, <u>Chung Shan Road</u>, <u>Tu-cheng City,Taipei Hsien</u>, <u>Taiwan</u>, <u>ROC</u> hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as Memory Module Assembly Including a Clip For Mounting a Heat Sink thereon for which the undersigned

[previously executed Ser. No	and filing date of	
[x]	is executing concurrently herewith		

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

PATENT REEL: 017930 FRAME: 0368

1.	Cheng-Tien Cui	June 2,2006		
	Cheng-Tier Lai inventor	Date	Witness	
2.	Zhi-Yong Zhou inventor	June 2,2006 Date	Witness	
3.	Qiao-Li Ding inventor	June 2,2006 Date	Witness	
4.	inventor	Date	Witness	
5.	inventor	Date	Witness	
6.	inventor	Date	Witness	
7.	inventor	Date	Witness	
8.	inventor	Date	Witness	

PATENT REEL: 017930 FRAME: 0369

RECORDED: 07/13/2006